



IC Packages, Assembly & Prototype Services



# Press Release

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FOR IMMEDIATE RELEASE

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## **IC Design, Packaging and Prototyping Firms Partner To Service Customers in Europe**

San Diego, CA, May 5, 2008 - Quik-Pak, a division of Delphon Industries, announced today that it will partner with UK based Optocap limited to provide European customers with a full turnkey solution for their IC packaging and prototyping needs. The two companies will co-exhibit at the upcoming IET & GSA International Semiconductor Forum in London, England May 14-15.

Quik-Pak provides IC packages, wafer preparation, assembly and prototyping services, specializing in open cavity plastic packages and assembly in 24 hours or less. Optocap's service focuses on the full product development cycle including assembly, qualification and failure analysis. The combination of the Quik-Pak open cavity packages and Optocap's local

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assembly capabilities will enable European customers to obtain "true" local quick-turn prototyping services.

**Background:**

Quik-Pak, a division of Delphon Industries, offers IC packages, assembly and prototype services. The company specializes in open-cavity plastic packages and assembly in 24 hours or less. A limitless array of open-cavity packages is available with no minimum quantity and can be provided as part of a turn-key assembly solution along with backgrinding, wafer dicing, die/wire bonding, remolding and marking/branding. Custom assembly services are also offered for ceramic packages, chip-on-board, stacked die, MEMS, etc. Quik-Pak's unique offerings deliver faster time to market and reduced prototype costs for new devices, while providing excellent flexibility, quality and customer service.

**About Optocap:**

Optocap Limited is a design, engineering and manufacturing service provider for packaging and assembly in the Microelectronics and Optoelectronics industry. Optocap's expertise in packaging and assembly solutions spans the development process: from design through prototyping, qualification, failure analysis, and transfer to low-cost volume manufacture.

**For further information:**

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